#### TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

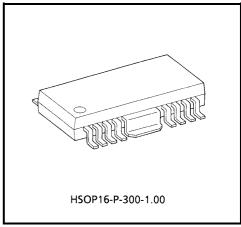
# **TA8466AF**

#### 3 PHASE FULL WAVE BRUSHLESS DC MOTOR DRIVER IC

TA8466AF is a semi-linear type 3 Phase Full Wave Brushless DC Motor Driver IC, developed as a cylinder motor driver for stationary VTRs.

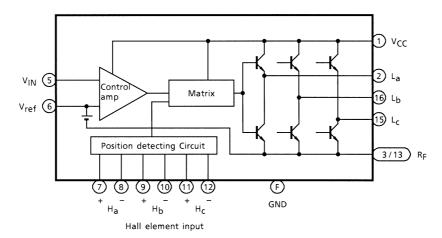
#### **FEATURES**

- Low Noise Soft Switching Drive
- One direction Drive
- Small Outer Capacitance
- Operating Supply Voltage: VCC = 7~17 V
- Hall Input Sensitivity :  $V_H = 30 \text{ mV}_{p-p}$
- Built-in Protective Diodes for All Input Pins
- Built-in Control Amp Reference Voltage (with Output Pins)
- Built-in Thermal Shutdown Circuit



Weight: 0.50 g (Typ.)

## **BLOCK DIAGRAM**



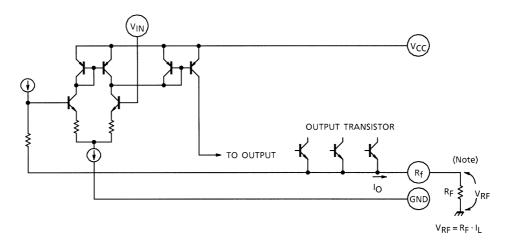
Pins (4) and (14) are NC. Keep Pin (6) open.

## **PIN FUNCTION**

PIN No.	SYMBOL	FUNCTIONAL			
1	V <sub>CC</sub>	Supply voltage input pin			
2	La	a-phase drive output pin			
3	R <sub>F</sub>	Output current detecting pin			
4	N.C.	N.C. pin			
5	V <sub>IN</sub>	Control amp positive input pin			
6	V <sub>ref</sub>	Control amp reference voltage output pin			
7	Ha⁺	a-phase Hall amp positive input pin			
8	Ha¯	a-phase Hall amp negative input pin			
9	H <sub>b</sub> ⁺	b-phase Hall amp positive input pin			
10	H <sub>b</sub> ⁻	b-phase Hall amp negative input pin			
11	H <sub>c</sub> <sup>+</sup>	c-phase Hall amp positive input pin			
12	H <sub>c</sub> ⁻	c-phase Hall amp negative input pin			
13	R <sub>F</sub>	Output current detecting pin			
14	N.C.	N.C. pin			
15	L <sub>c</sub>	c-phase drive output pin			
16	L <sub>b</sub>	b-phase drive output pin			
F	FIN	(Connect to GND)			

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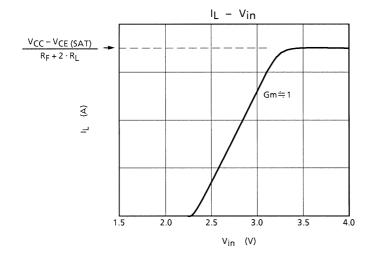
## 1. Control input circuit



Feedback circuit of output currents is built into IC, that is, the voltage feedback is proportional to the output current in  $R_F$ .

Note: The common impedance inside IC is taken into consideration in providing two  $R_F$  terminals. Short two pins ((3) and (13)) in using them.

### **INPUT / OUTPUT CHARACTERISTICS**



RL : Output coil resistance VCE(SAT) : Output transistor saturation voltage

(upper / lower total)

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## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Supply Voltage	$V_{CC}$	18	V	
Output Current	I <sub>O (MAX.)</sub>	0.7	Α	
Power Dissipation	P <sub>D</sub>	0.9 (Note 1)	W	
1 ower bissipation	ט י	8.3 (Note 2)		
Operating Temperature	T <sub>opr</sub>	-30~75	°C	
Storage Temperature	T <sub>stg</sub>	-55~150	°C	

Note 1: Single body

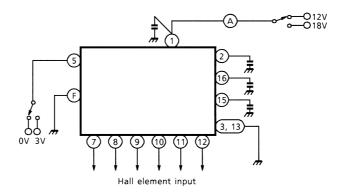
Note 2: Infinite heat sink mounting

## ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 12 V, Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Supply Current		I <sub>CC1</sub>	1	Output open, V <sub>IN</sub> = 0 V	1.5	3.0	4.5	mA	
		I <sub>CC2</sub>		Output open, V <sub>IN</sub> = 3 V	18	50	95		
		I <sub>CC3</sub>		Output open, V <sub>CC</sub> = 18 V, V <sub>IN</sub> = 3 V	18	55	110		
Referen		Voltage	V <sub>ref</sub>			2.25	2.35	2.45	V
Control Amp	Control Gain		G <sub>m</sub>	2	R <sub>F</sub> = 0.47Ω, V <sub>IN</sub> = 2.45 V / 2.6 V	_	1.0	_	A/V
	Input Curre	Input Current			V <sub>IN</sub> = 3.5 V	_	2.5	10	μA
	Reference Voltage Ripple Compression Rate		R <sub>r</sub>		V <sub>CC</sub> = 7 V / 18 V	-53	-64	_	dB
Leak Current Upper Side Lower Side		I <sub>OL (U)</sub>	3	V <sub>CC</sub> = 18 V	_	_	50	μА	
		I <sub>OL (L)</sub>		V <sub>CC</sub> = 18 V	_	_	50		
Saturation Voltage Upper Side Lower Side		V <sub>sat (U)</sub>	4	I <sub>L</sub> = 0.7 A	_	1.2	1.6	V	
		Lower Side	V <sub>sat (L)</sub>	4	I <sub>L</sub> = 0.7 A	1	0.5	0.85	v
Residual Output Voltage		V <sub>OR</sub>	2	V <sub>IN</sub> = 0 V	1	0	12	mV	
Hall Amp	Difference Input Voltage Range		V <sub>H</sub>	6		30	_	200	mV <sub>p-p</sub>
	Common-Mode Input Voltage Range		V <sub>CMRH</sub>	5		2.0	_	V <sub>CC</sub>	V
Thermal Shutdown Operating Temperature		TSD	_		-	175	_	°C	

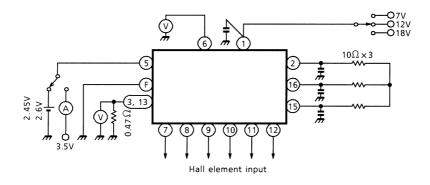
## **TEST CIRCUIT 1**

 $I_{\text{CC1}},\,I_{\text{CC2}},\,I_{\text{CC3}}$ 



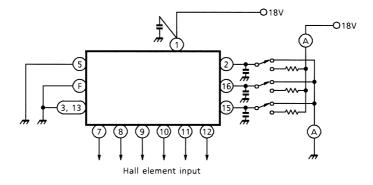
## **TEST CIRCUIT 2**

 $V_{ref}$ ,  $G_V$ ,  $I_{in}$ ,  $R_r$ ,  $V_{or}$ 



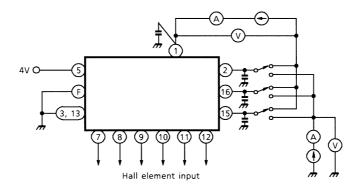
### **TEST CIRCUIT 3**

I<sub>OL</sub> (U), I<sub>OL</sub> (L)



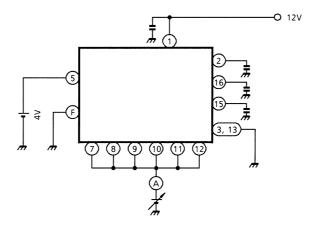
## **TEST CIRCUIT 4**

## V<sub>sat (U)</sub>, V<sub>sat (L)</sub>



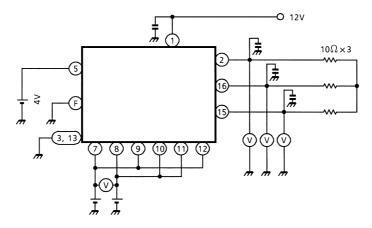
## **TEST CIRCUIT 5**

## V<sub>CMRH</sub>



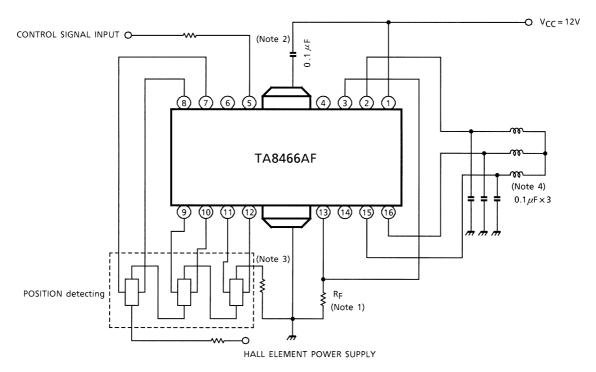
## **TEST CIRCUIT 6**

 $V_{\text{H}}$ 



 $V_{\mbox{\scriptsize H}}\!:$  Functional check to be made at 30  $\mbox{mV}_{\mbox{\scriptsize p-p}}$  / 200  $\mbox{mV}_{\mbox{\scriptsize p-p}}.$ 

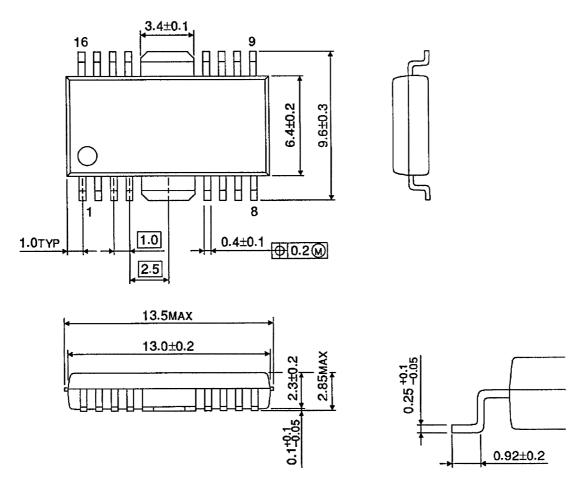
#### **APPLICATION CIRCUIT**



- Note 1: R<sub>F</sub> value is determined by coil impedance, F / V conversion voltage (control input), and necessary activation torque. But determine it at about  $0.3\sim5~\Omega$ .
- Note 2: Connect this condenser directly to IC fin (GND). Still larger capacity may be necessary depending upon common impedance among supply lines.
- Note 3: Write Hall sensor GND line and coil current R<sub>F</sub> line without common impedance.
- Note 4: It may be necessary to change condenser capacity depending upon motor type, to prevent noise and oscillation.
- Note 5: Utmost care is necessary in the design of the output line, V<sub>CC</sub> and GND line since IC may be destroyed due to short–circuit between outputs, air contamination fault, or fault by improper grounding.

## **PACKAGE DIMENSIONS**

HSOP16-P-300-1.00 Unit: mm



Weight: 0.50 g (Typ.)

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